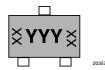
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Two-Line ESD Protection in SOT-23

20512

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MARKING (example only)



YYY = type code (see table below) XX = date code

FEATURES

- Two-line ESD-protection device
- ESD-protection acc. IEC 61000-4-2 ± 30 kV contact discharge ± 30 kV air discharge
- ESD capability according to AEC-Q101: human body model: class H3B: > 8 kV
- Space saving SOT-23 package
- e3 Sn
- AEC-Q101 qualified available
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

Pb-free
(e3)
RoHS
COMPLIANT
HALOGEN
FREE
Available

GREEN (5-2008)

 \square

ORDERING INFORMATION									
DADT	ENVIR	ENVIRONMENTAL AND QUALITY CODE			PACKAG	ING CODE			
NUMBER	(EXAMPLE) OUALIFIED LEAD (Pb)-FREE DI ATED (8 mm TAPE), (8 mm TAPE		b)-FREE TIN		LEAD (Pb)-FREE		10K PER 13" REEL (8 mm TAPE),	ORDERING CODE (EXAMPLE)	
(2/0 000 22)			GREEN	PLATED	15K/BOX = MŐQ 10K/BOX = MŐQ				
GSOT05C-		E		3	-08		GSOT05C-E3-08		
GSOT05C-			G	3	-08		GSOT05C-G3-08		
GSOT05C-	Н	E		3	-08		GSOT05C-HE3-08		
GSOT05C-	Н		G	3	-08		GSOT05C-HG3-08		
GSOT05C-		E		3		-18	GSOT05C-E3-18		
GSOT05C-			G	3		-18	GSOT05C-G3-18		
GSOT05C-	Н	E		3		-18	GSOT05C-HE3-18		
GSOT05C-	Н		G	3		-18	GSOT05C-HG3-18		

PACKA	PACKAGE DATA							
DEVICE NAME	PACKAGE NAME	TYPE CODE	ENVIRONMENTAL STATUS	WEIGHT	MOLDING COMPOUND FLAMMABILITY RATING	MOISTURE SENSITIVITY LEVEL	SOLDERING CONDITIONS	
GSOT03C	SOT-23	03C	Standard	8.8 mg	UL 94 V-0	MSL level 1	260 °C/10 s at terminals	
0001000	001 20	C1G	Green	8.1 mg	020400	(according J-STD-020)	200 0/103 at terminais	
GSOT04C	SOT-23	04C	Standard	8.8 mg	UL 94 V-0	MSL level 1	260 °C/10 s at terminals	
0301040	301-23	C8G	Green	8.1 mg	01 94 0-0	(according J-STD-020)		
GSOT05C	SOT-23	05C	Standard	8.8 mg	UL 94 V-0	MSL level 1	260 °C/10 s at terminals	
0301030	301-23	C2G	Green	8.1 mg	01 94 0-0	(according J-STD-020)		
GSOT08C	SOT-23	08C	Standard	8.8 mg	UL 94 V-0	MSL level 1	260 °C/10 s at terminals	
0301000	301-23	C3G	Green	8.1 mg	01 94 0-0	(according J-STD-020)		
GSOT12C	SOT-23	12C	Standard	8.8 mg	UL 94 V-0	MSL level 1	260 °C/10 s at terminals	
0301120	301-23	C4G	Green	8.1 mg	OL 94 V-0	(according J-STD-020)		
GSOT15C	SOT-23	15C	Standard	8.8 mg	UL 94 V-0	MSL level 1	260 °C/10 s at terminals	
0301130	301-23	C5G	Green	8.1 mg	OL 94 V-0	(according J-STD-020)		
GSOT24C	SOT-23	24C	Standard	8.8 mg	UL 94 V-0	MSL level 1	260 °C/10 s at terminals	
6301240	301-23	C6G	Green	8.1 mg	01 94 0-0	(according J-STD-020)	200 O/TO S at terminals	
GSOT36C	SOT-23	36C	Standard	8.8 mg	UL 94 V-0	MSL level 1	260 °C/10 s at terminals	
6301300	301-23	C7G	Green	8.1 mg	01 94 0-0	(according J-STD-020)	200 O/TO S at terminals	

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1 For technical questions, contact: ESDprotection@vishay.com



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ABSOLUTE MAXIMUM RATINGS GSOT03C				
PARAMETER	TEST CONDITIONS	SYMBOL	VALUE	UNIT
Poak pulso ourrent	Pin 1 to 3 or pin 2 to 3 acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot	I	30	А
	Pin 1 to 2 or pin 2 to 1; pin 3 not connected acc. IEC 61000-4-5, $t_p = 8/20 \ \mu$ s; single shot	- I _{PPM}	30	А
Peak pulse power	Pin 1 to 3 or pin 2 to 3 acc. IEC 61000-4-5, $t_p = 8/20 \ \mu$ s; single shot	P _{PP}	369	W
reak puise power	Pin 1 to 2 or pin 2 to 1; pin 3 not connected acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot	Грр	504	W
ESD immunity	Contact discharge acc. IEC 61000-4-2; 10 pulses	VESD	± 30	kV
ESD Immunity	Air discharge acc. IEC 61000-4-2; 10 pulses	VESD	30 30 369 504	kV
Operating temperature	Junction temperature	TJ	-55 to +150	°C
Storage temperature		T _{STG}	-55 to +150	°C

ABSOLUTE MAXIMUM RATINGS GSOT04C					
PARAMETER	TEST CONDITIONS	SYMBOL	VALUE	UNIT	
Dock pulse ourrent	Pin 1 to 3 or pin 2 to 3 acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot	1	30	А	
	Pin 1 to 2 or pin 2 to 1; pin 3 not connected acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot	IPPM	30	А	
Peak pulse power	Pin 1 to 3 or pin 2 to 3 acc. IEC 61000-4-5, t _p = 8/20 μs; single shot	P _{PP}	429	W	
reak puise power	Pin 1 to 2 or pin 2 to 1; pin 3 not connected acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot	Грр	564	W	
ESD immunity	Contact discharge acc. IEC 61000-4-2; 10 pulses	V	± 30	kV	
	Air discharge acc. IEC 61000-4-2; 10 pulses	V _{ESD}	± 30	kV	
Operating temperature	Junction temperature	T _J -55 to	-55 to +150	°C	
Storage temperature		T _{STG}	-55 to +150	°C	

ABSOLUTE MAXIMUM RATINGS GSOT05C					
PARAMETER	TEST CONDITIONS	SYMBOL	VALUE	UNIT	
Peak pulse current	Pin 1 to 3 or pin 2 to 3 acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot		30	A	
reak puise current	Pin 1 to 2 or pin 2 to 1; pin 3 not connected acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot	IPPM		А	
Peak pulse power	Pin 1 to 3 or pin 2 to 3 acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot	P _{PP}	480	W	
reak puise power	Pin 1 to 2 or pin 2 to 1; pin 3 not connected acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot	ГРР	612	W	
ESD immunity	Contact discharge acc. IEC 61000-4-2; 10 pulses	V _{ESD}	± 30	kV	
	Air discharge acc. IEC 61000-4-2; 10 pulses	VESD	± 30	kV	
Operating temperature	Junction temperature	TJ	-55 to +150	°C	
Storage temperature		T _{STG}	-55 to +150	°C	

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ABSOLUTE MAXIMUM RATINGS GSOT08C				
PARAMETER	TEST CONDITIONS	SYMBOL	VALUE	UNIT
Peak pulse current	Pin 1 to 3 or pin 2 to 3 acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot		18	А
reak puise current	Pin 1 to 2 or pin 2 to 1; pin 3 not connected acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot	'PPM	18	А
Peak pulse power	Pin 1 to 3 or pin 2 to 3 acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot	P _{PP}	345	W
reak puise power	Pin 1 to 2 or pin 2 to 1; pin 3 not connected acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot	грр	400	W
ESD immunity	Contact discharge acc. IEC 61000-4-2; 10 pulses	V _{ESD}	± 30	kV
	Air discharge acc. IEC 61000-4-2; 10 pulses	VESD	± 30	kV
Operating temperature	Junction temperature	TJ	-55 to +150	°C
Storage temperature		T _{STG}	-55 to +150	°C

ABSOLUTE MAXIMUM RATINGS GSOT12C					
PARAMETER	TEST CONDITIONS	SYMBOL	VALUE	UNIT	
Peak pulse current	Pin 1 to 3 or pin 2 to 3 acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot		12	А	
reak puise current	Pin 1 to 2 or pin 2 to 1; pin 3 not connected acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot	IPPM	12	А	
Peak pulse power	Pin 1 to 3 or pin 2 to 3 acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot	P _{PP}	312	W	
reak puise power	Pin 1 to 2 or pin 2 to 1; pin 3 not connected acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot	ГРР	337	W	
ESD immunity	Contact discharge acc. IEC 61000-4-2; 10 pulses	V	± 30	kV	
	Air discharge acc. IEC 61000-4-2; 10 pulses	V _{ESD}	± 30	kV	
Operating temperature	Junction temperature	TJ	-55 to +150	°C	
Storage temperature		T _{STG}	-55 to +150	°C	

ABSOLUTE MAXIMUM RATINGS GSOT15C					
PARAMETER	TEST CONDITIONS	SYMBOL	VALUE	UNIT	
Peak pulse current	Pin 1 to 3 or pin 2 to 3 acc. IEC 61000-4-5, t_p = 8/20 µs; single shot		8	А	
reak puise current	Pin 1 to 2 or pin 2 to 1; pin 3 not connected acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot	IPPM		А	
Peak pulse power	Pin 1 to 3 or pin 2 to 3 acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot	P _{PP}	8 8 345 400 ± 30 ± 30 -55 to +150	W	
reak puise power	Pin 1 to 2 or pin 2 to 1; pin 3 not connected acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot	Грр		W	
ESD immunity	Contact discharge acc. IEC 61000-4-2; 10 pulses	V	± 30	kV	
	Air discharge acc. IEC 61000-4-2; 10 pulses	V _{ESD}	± 30	kV	
Operating temperature	Junction temperature	TJ	-55 to +150	°C	
Storage temperature		T _{STG}	-55 to +150	°C	



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ABSOLUTE MAXIMUM RATINGS GSOT24C				
PARAMETER	TEST CONDITIONS	SYMBOL	VALUE	UNIT
Peak pulse current	Pin 1 to 3 or pin 2 to 3 acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot	I	5	А
Peak pulse current Pin 1 to 2 or pin 2 to 1; pin 3 not connected acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot	IPPM	5	А	
Peak pulse power	Pin 1 to 3 or pin 2 to 3 acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot	P _{PP}	235	W
reak puise power	Pin 1 to 2 or pin 2 to 1; pin 3 not connected acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot	ГРР	240	W
ESD immunity	Contact discharge acc. IEC 61000-4-2; 10 pulses	V	5 5 235	kV
	Air discharge acc. IEC 61000-4-2; 10 pulses	V _{ESD}	± 30	kV
Operating temperature	Junction temperature	TJ	-55 to +150	°C
Storage temperature		T _{STG}	-55 to +150	°C

ABSOLUTE MAXIMUM RATINGS GSOT36C					
PARAMETER	TEST CONDITIONS	SYMBOL	VALUE	UNIT	
Peak pulse current	Pin 1 to 3 or pin 2 to 3 acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot		VALUE 3.5 3.5 248 252 ± 30 ± 30 -55 to +150 -55 to +150	А	
reak puise current	Pin 1 to 2 or pin 2 to 1; pin 3 not connected acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot	IPPM		А	
Peak pulse power	Pin 1 to 3 or pin 2 to 3 acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot	P _{PP}	3.5 3.5 248 252 ± 30 ± 30 -55 to +150	W	
reak puise power	Pin 1 to 2 or pin 2 to 1; pin 3 not connected acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot	ГРР		W	
ESD immunity	Contact discharge acc. IEC 61000-4-2; 10 pulses	M	± 30	kV	
	Air discharge acc. IEC 61000-4-2; 10 pulses	V _{ESD}	3.5 3.5 248 252 ± 30 ± 30 $-55 \text{ to } +150$	kV	
Operating temperature	Junction temperature	TJ	-55 to +150	°C	
Storage temperature		T _{STG}	-55 to +150	°C	



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BIAs-MODE (2-line Bidirectional Asymmetrical protection mode)

With the GSOTxxC two signal- or data-lines (L1, L2) can be protected against voltage transients. With pin 3 connected to ground and pin 1 and pin 2 connected to a signal- or data-line which has to be protected. As long as the voltage level on the data- or signal-line is between 0 V (ground level) and the specified Maximum Reverse Working Voltage (V_{RWM}) the protection diode between pin 2 and pin 3 and between pin 1 and pin 3 offers a high isolation to the ground line. The protection device behaves like an open switch.

As soon as any positive transient voltage signal exceeds the breakdown voltage level of the protection diode, the diode becomes conductive and shorts the transient current to ground. Now the protection device behaves like a closed switch. The Clamping Voltage (V_C) is defined by the breakdown voltage (V_{BR}) level plus the voltage drop at the series impedance (resistance and inductance) of the protection diode.

Any negative transient signal will be clamped accordingly. The negative transient current is flowing in the forward direction through the protection diode. The low Forward Voltage (V_F) clamps the negative transient close to the ground level.

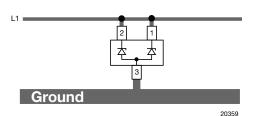
Due to the different clamping levels in forward and reverse direction the GSOTxxC clamping behavior is Bidirectional and Asymmetrical (BiAs).



If a higher surge current or peak pulse current (I_{PP}) is needed, both protection diodes in the GSOTxxC can also be used in parallel in order to "double" the performance.

This offers:

- double surge power = double peak pulse current (2 x I_{PPM})
- half of the line inductance = reduced clamping voltage
- half of the line resistance = reduced clamping voltage
- double line capacitance (2 x C_D)
- double reverse leakage current (2 x I_R)



ELECTRICAL CHARACTERISTICS GSOT03C (T _{amb} = 25 °C unless otherwise specified) between pin 1 to pin 3 or pin 2 to pin 3							
PARAMETER	TEST CONDITIONS/REMARKS	SYMBOL	MIN.	TYP.	MAX.	UNIT	
Protection paths	Number of lines which can be protected	N _{channel}	-	-	2	lines	
Reverse stand-off voltage	Max. reverse working voltage	V _{RWM}	-	-	3.3	V	
Reverse voltage	at I _R = 100 μA	V _R	3.3	-	-	V	
Reverse current	at V _R = 3.3 V	I _R	-	-	100	μA	
Reverse breakdown voltage	at I _R = 1 mA	V _{BR}	4.0	4.6	5.5	V	
Poweree elemping voltage	at I _{PP} = 1 A	V	-	5.7	7.5	V	
Reverse clamping voltage	at I _{PP} = I _{PPM} = 30 A	V _C	-	10	MAX. 2 3.3 - 100 5.5	V	
Ferward elemetric valtage	at I _{PP} = 1 A	V	-	1	1.2	V	
Forward clamping voltage	at I _{PP} = I _{PPM} = 30 A	V _F	-	4.5	-	V	
Capacitanaa	at $V_R = 0 V$; f = 1 MHz	6	-	420	600	pF	
Capacitance	at V _R = 1.6 V; f = 1 MHz	C _D	-	260	-	pF	

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Document Number: 85824

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ELECTRICAL CHARACTERISTICS GSOT04C (T _{amb} = 25 °C unless otherwise specified) between pin 1 to pin 3 or pin 2 to pin 3								
PARAMETER	TEST CONDITIONS/REMARKS	SYMBOL	MIN.	TYP.	MAX.	UNIT		
Protection paths	Number of lines which can be protected	N _{channel}	-	-	2	lines		
Reverse stand-off voltage	Max. reverse working voltage	V _{RWM}	-	-	4	V		
Reverse voltage	at I _R = 20 μA	V _R	4	-	-	V		
Reverse current	at V _R = 4 V	I _R	-	-	20	μA		
Reverse breakdown voltage	at I _R = 1 mA	V _{BR}	5	6.1	7	V		
	at I _{PP} = 1 A	N/	-	7.5	9	V		
Reverse clamping voltage	at I _{PP} = I _{PPM} = 30 A	V _C	-	11.2	14.3	V		
Forward elemping voltage	at I _{PP} = 1 A	V	-	1	1.2	V		
Forward clamping voltage	at I _{PP} = I _{PPM} = 30 A	V _F	-	4.5	-	V		
Capacitance	at $V_R = 0$ V; f = 1 MHz	CD	-	310	450	pF		
	at $V_R = 2 V$; f = 1 MHz		-	200	-	pF		

ELECTRICAL CHARACTERISTICS GSOT05C (T _{amb} = 25 °C unless otherwise specified) between pin 1 to pin 3 or pin 2 to pin 3								
PARAMETER	TEST CONDITIONS/REMARKS	SYMBOL	MIN.	TYP.	MAX.	UNIT		
Protection paths	Number of lines which can be protected	N _{channel}	-	-	2	lines		
Reverse stand-off voltage	Max. reverse working voltage	V _{RWM}	-	-	5	V		
Reverse voltage	at I _R = 10 μA	V _R	5	-	-	V		
Reverse current	at V _R = 5 V	I _R	-	-	10	μA		
Reverse breakdown voltage	at I _R = 1 mA	V _{BR}	6	6.8	8	V		
Deverse elemping veltage	at I _{PP} = 1 A	V	-	7	8.7	V		
Reverse clamping voltage	at I _{PP} = I _{PPM} = 30 A	Vc	-	12	16	V		
	at I _{PP} = 1 A	N	-	1	1.2	V		
Forward clamping voltage	at I _{PP} = I _{PPM} = 30 A	V _F	-	4.5	-	V		
Orneritence	at $V_R = 0 V$; f = 1 MHz	- C _D	-	260	350	pF		
Capacitance	at V _R = 2.5 V; f = 1 MHz		-	150	-	pF		

between pin 1 to pin 3 or	TERISTICS GSOT08C ($T_{amb} = 25$ pin 2 to pin 3	C unless (Junerwise	specified)	
PARAMETER	TEST CONDITIONS/REMARKS	SYMBOL	MIN.	TYP.	MAX.	UNIT
Protection paths	Number of lines which can be protected	N _{channel}	-	-	2	lines
Reverse stand-off voltage	Max. reverse working voltage	V _{RWM}	-	-	8	V
Reverse voltage	at I _R = 5 μA	V _R	8	-	-	V
Reverse current	at V _R = 8 V	I _R	-	-	5	μA
Reverse breakdown voltage	at I _R = 1 mA	V _{BR}	9	10	11	V
Deverse elemping veltage	at I _{PP} = 1 A	V	-	10.7	13	V
Reverse clamping voltage	at I _{PP} = I _{PPM} = 18 A	V _C	-	15.2	19.2	V
	at I _{PP} = 1 A	N	-	1	1.2	V
Forward clamping voltage	at I _{PP} = I _{PPM} = 18 A	V _F	-	3	-	V
Capacitance	at $V_R = 0$ V; f = 1 MHz	CD	-	160	250	pF
	at $V_R = 4 V$; f = 1 MHz		-	80	-	pF

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> UNIT lines ۷ ۷ μA



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ELECTRICAL CHARAC between pin 1 to pin 3 or	TERISTICS GSOT12C (T _{amb} = 25 pin 2 to pin 3	°C unless	otherwise	specified)	
PARAMETER	TEST CONDITIONS/REMARKS	SYMBOL	MIN.	TYP.	MAX.	UNIT
Protection paths	Number of lines which can be protected	N _{channel}	-	-	2	lines
Reverse stand-off voltage	Max. reverse working voltage	V _{RWM}	-	-	12	V
Reverse voltage	at I _R = 1 μA	V _R	12	-	-	V
Reverse current	at V _R = 12 V	I _R	-	-	1	μA
Reverse breakdown voltage	at I _R = 1 mA	V _{BR}	13.5	15	16.5	V
Deverse elemening veltage	at I _{PP} = 1 A	V	-	15.4	18.7	V
Reverse clamping voltage	at I _{PP} = I _{PPM} = 12 A	V _C	-	21.2	26	V
Forward alamping valtage	at I _{PP} = 1 A	V	-	1	1.2	V
Forward clamping voltage	at I _{PP} = I _{PPM} = 12 A	V _F	-	2.2	-	V
Canaaitanaa	at $V_R = 0 V$; f = 1 MHz	- C _D	-	115	150	pF
Capacitance	at $V_R = 6 V$; f = 1 MHz		-	50	-	pF

ELECTRICAL CHARACE between pin 1 to pin 3 or	TERISTICS GSOT15C ($T_{amb} = 25$ pin 2 to pin 3	°C unless	otherwise	specified)		
PARAMETER	TEST CONDITIONS/REMARKS	SYMBOL	MIN.	TYP.	MAX.	Γ
Protection paths	Number of lines which can be protected	N _{channel}	-	-	2	
Reverse stand-off voltage	Max. reverse working voltage	V _{RWM}	-	-	15	
Reverse voltage	at I _R = 1 μA	V _R	15	-	-	
Reverse current	at V _R = 15 V	I _R	-	-	1	
Reverse breakdown voltage	at In – 1 mA	Vpp	16 5	18	20	

Reverse breakdown voltage	at I _R = 1 mA	V _{BR}	16.5	18	20	V
Reverse clamping voltage	at I _{PP} = 1 A	V _C	-	19.4	23.5	V
neverse clamping voltage	at I _{PP} = I _{PPM} = 8 A	۷C	-	24.8	28.8	V
Forward clamping voltage	at I _{PP} = 1 A	M	-	1	1.2	V
Forward clamping voltage	at I _{PP} = I _{PPM} = 8 A	V _F	-	1.8	-	V
Capacitance	at $V_R = 0 V$; f = 1 MHz	C-	-	90	120	pF
Capacitarice	at $V_R = 7.5 V$; f = 1 MHz	C _D	-	35	-	pF

PARAMETER	TEST CONDITIONS/REMARKS	SYMBOL	MIN.	TYP.	MAX.	UNIT
Protection paths	Number of lines which can be protected	N _{channel}	-	-	2	lines
Reverse stand-off voltage	Max. reverse working voltage	V _{RWM}	-	-	24	V
Reverse voltage	at I _R = 1 µA	V _R	24	-	-	V
Reverse current	at V _R = 24 V	I _R	-	-	1	μA
Reverse breakdown voltage	at I _R = 1 mA	V _{BR}	27	30	33	V
	at I _{PP} = 1 A	N	-	34	41	V
Reverse clamping voltage	at I _{PP} = I _{PPM} = 5 A	V _C	-	41	47	V
	at I _{PP} = 1 A	N	-	1	1.2	V
Forward clamping voltage	at I _{PP} = I _{PPM} = 5 A	V _F	-	1.4	-	V
Capacitance	at V _R = 0 V; f = 1 MHz	C _D	-	65	80	pF
	at V _B = 12 V; f = 1 MHz		-	20	-	pF

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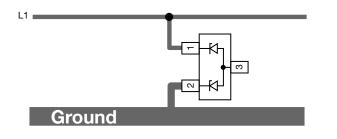
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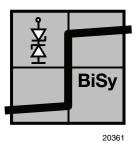
ELECTRICAL CHARAC between pin 1 to pin 3 or	TERISTICS GSOT36C (T _{amb} = 25 pin 2 to pin 3	°C unless o	otherwise	specified)	
PARAMETER	TEST CONDITIONS/REMARKS	SYMBOL	MIN.	TYP.	MAX.	UNIT
Protection paths	Number of lines which can be protected	N _{channel}	-	-	2	lines
Reverse stand-off voltage	Max. reverse working voltage	V _{RWM}	-	-	36	V
Reverse voltage	at I _R = 1 μA	V _R	36	-	-	V
Reverse current	at V _R = 36 V	I _R	-	-	1	μA
Reverse breakdown voltage	at I _R = 1 mA	V _{BR}	39	43	47	V
Deverse elemping veltage	at I _{PP} = 1 A	V	-	49	60	V
Reverse clamping voltage	at I _{PP} = I _{PPM} = 3.5 A	V _C	-	59	71	V
	at I _{PP} = 1 A	N	-	1	1.2	V
Forward clamping voltage	at I _{PP} = I _{PPM} = 3.5 A	V _F	-	1.3	-	V
Orneriteree	at $V_R = 0 V$; f = 1 MHz	- C _D	-	52	65	pF
Capacitance	at V _R = 18 V; f = 1 MHz		-	12	-	pF

BiSy-MODE (1-line bidirectional symmetrical protection mode)

If a bipolar symmetrical protection device is needed the GSOTxxC can also be used as a single line protection device. Therefore pin 1 has to be connected to the signal- or data-line (L1) and pin 2 to ground (or vice versa). Pin 3 must not be connected. Positive and negative voltage transients will be clamped in the same way. The clamping current through the GSOTxxC passes one diode in forward direction and the other one in reverse direction. The clamping voltage (V_C) is defined by the breakthrough voltage (V_{BR}) level of one diode plus the forward voltage of the other diode plus the voltage drop at the series impedances (resistances and inductances) of the protection device.

Due to the same clamping levels in positive and negative direction the GSOTxxC voltage clamping behaviour is bidirectional and symmetrical (BiSy).





ELECTRICAL CHARACTERISTICS GSOT03C (T _{amb} = 25 °C unless otherwise specified) between pin 1 to pin 2 or pin 2 to pin1; pin 3 not connected								
PARAMETER	TEST CONDITIONS/REMARKS	SYMBOL	MIN.	TYP.	MAX.	UNIT		
Protection paths	Number of lines which can be protected	N _{channel}	-	-	1	lines		
Reverse stand-off voltage	Max. reverse working voltage	V _{RWM}	-	-	3.8	V		
Reverse voltage	at I _R = 100 μA	V _R	3.8	-	-	V		
Reverse current	at V _R = 3.8 V	I _R	-	-	100	μA		
Reverse breakdown voltage	at I _R = 1 mA	V _{BR}	4.5	5.3	6.2	V		
Deverse elemning veltage	at I _{PP} = 1 A	V	-	7	8.4	V		
Reverse clamping voltage	at $I_{PP} = I_{PPM} = 30 \text{ A}$	V _C	-	14	16.8	V		
Capacitance	at $V_R = 0 V$; f = 1 MHz	C _D	-	210	300	pF		
	at V _R = 1.6 V; f = 1 MHz		-	190	-	pF		



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	TERISTICS GSOT04C ($T_{amb} = 25$ pin 2 to pin1; pin 3 not connected	°C unless	otherwise	specified)	
PARAMETER	TEST CONDITIONS/REMARKS	SYMBOL	MIN.	TYP.	MAX.	UNIT
Protection paths	Number of lines which can be protected	N _{channel}	-	-	1	lines
Reverse stand-off voltage	Max. reverse working voltage	V _{RWM}	-	-	4.5	V
Reverse voltage	at I _R = 20 μA	V _R	4.5	-	-	V
Reverse current	at V _R = 4.5 V	I _R	-	-	20	μA
Reverse breakdown voltage	at I _R = 1 mA	V _{BR}	5.5	6.8	7.7	V
	at I _{PP} = 1 A	V	-	7.5	9	V
Reverse clamping voltage	at I _{PP} = I _{PPM} = 30 A	V _C	-	15.7	18.8	V
Capacitance	at $V_R = 0 V$; f = 1 MHz	CD	-	155	225	pF
	at $V_R = 2 V$; f = 1 MHz		-	135	-	pF

ELECTRICAL CHARACTERISTICS GSOT05C (T_{amb} = 25 °C unless otherwise specified) between pin 1 to pin 2 or pin 2 to pin1; pin 3 not connected

between pint to pint to pint to pint, pint not connected								
PARAMETER	TEST CONDITIONS/REMARKS	SYMBOL	MIN.	TYP.	MAX.	UNIT		
Protection paths	Number of lines which can be protected	N _{channel}	-	-	1	lines		
Reverse stand-off voltage	Max. reverse working voltage	V _{RWM}	-	-	5.5	V		
Reverse voltage	at I _R = 10 μA	V _R	5.5	-	-	V		
Reverse current	at V _R = 5.5 V	I _R	-	-	10	μA		
Reverse breakdown voltage	at I _R = 1 mA	V _{BR}	6.5	7.5	8.7	V		
	at I _{PP} = 1 A	V	-	8.1	9.7	V		
Reverse clamping voltage	at I _{PP} = I _{PPM} = 30 A	V _C	-	17	20.4	V		
Capacitance	at $V_R = 0 V$; f = 1 MHz	C _D	-	130	175	pF		
	at $V_R = 4 V$; f = 1 MHz		-	100	-	pF		

ELECTRICAL CHARACTERISTICS GSOT08C ($T_{amb} = 25$ °C unless otherwise specified) between pin 1 to pin 2 or pin 2 to pin 1; pin 3 not connected

between pin 1 to pin 2 or pin 2 to pin 1; pin 3 not connected								
PARAMETER	TEST CONDITIONS/REMARKS	SYMBOL	MIN.	TYP.	MAX.	UNIT		
Protection paths	Number of lines which can be protected	N _{channel}	-	-	1	lines		
Reverse stand-off voltage	Max. reverse working voltage	V _{RWM}	-	-	8.5	V		
Reverse voltage	at I _R = 5 μA	V _R	8.5	-	-	V		
Reverse current	at V _R = 8.5 V	I _R	-	-	5	μA		
Reverse breakdown voltage	at I _R = 1 mA	V _{BR}	9.5	10.7	11.7	V		
Povorso clamping voltago	at I _{PP} = 1 A	Vc	-	11.7	14	V		
Reverse clamping voltage	at I _{PP} = I _{PPM} = 18 A	vс	-	18.5	22.2	V		
Capacitance	at $V_R = 0 V$; f = 1 MHz	CD	-	80	125	pF		
	at $V_R = 4 V$; f = 1 MHz		-	60	-	pF		

ELECTRICAL CHARACTERISTICS GSOT12C (T_{amb} = 25 °C unless otherwise specified) between pin 1 to pin 2 or pin 2 to pin1; pin 3 not connected

PARAMETER	TEST CONDITIONS/REMARKS	SYMBOL	MIN.	TYP.	MAX.	UNIT
Protection paths	Number of lines which can be protected	N _{channel}	-	-	1	lines
Reverse stand-off voltage	Max. reverse working voltage	V _{RWM}	-	-	12.5	V
Reverse voltage	at I _R = 1 μA	V _R	12.5	-	-	V
Reverse current	at V _R = 12.5 V	I _R	-	-	1	μA
Reverse breakdown voltage	at I _R = 1 mA	V _{BR}	13.5	15.7	16.5	V
Reverse clamping voltage	at I _{PP} = 1 A	V _C	-	16.4	19.7	V
	at I _{PP} = I _{PPM} = 12 A		-	23.4	28.1	V
Capacitance	at $V_R = 0 V$; f = 1 MHz	CD	-	58	75	pF
	at V _R = 7.5 V; f = 1 MHz		-	36	-	pF

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ELECTRICAL CHARACTERISTICS GSOT15C ($T_{amb} = 25$ °C unless otherwise specified) between pin 1 to pin 2 or pin 2 to pin1; pin 3 not connected						
PARAMETER	TEST CONDITIONS/REMARKS	SYMBOL	MIN.	TYP.	MAX.	UNIT
Protection paths	Number of lines which can be protected	N _{channel}	-	-	1	lines
Reverse stand-off voltage	Max. reverse working voltage	V _{RWM}	-	-	15.5	V
Reverse voltage	at I _R = 1 μA	V _R	15.5	-	-	V
Reverse current	at V _R = 15.5 V	I _R	-	-	1	μA
Reverse breakdown voltage	at I _R = 1 mA	V _{BR}	17	18.7	20.7	V
Reverse clamping voltage	at I _{PP} = 1 A	V _C	-	20.4	24.5	V
	at I _{PP} = I _{PPM} = 8 A		-	26.6	30.6	V
Capacitance	at $V_R = 0 V$; f = 1 MHz	- C _D	-	45	60	pF
	at V _R = 7.5 V; f = 1 MHz		-	25	-	pF

ELECTRICAL CHARACTERISTICS GSOT24C ($T_{amb} = 25$ °C unless otherwise specified) between pin 1 to pin 2 or pin 2 to pin1; pin 3 not connected

PARAMETER	TEST CONDITIONS/REMARKS	SYMBOL	MIN.	TYP.	MAX.	UNIT
Protection paths	Number of lines which can be protected	N _{channel}	-	-	1	lines
Reverse stand-off voltage	Max. reverse working voltage	V _{RWM}	-	-	24.5	V
Reverse voltage	at I _R = 1 μA	V _R	24.5	-	-	V
Reverse current	at V _R = 24.5 V	I _R	-	-	1	μA
Reverse breakdown voltage	at I _R = 1 mA	V _{BR}	27.5	30.7	33.7	V
Reverse clamping voltage	at I _{PP} = 1 A	V _C	-	34	41	V
	at $I_{PP} = I_{PPM} = 5 A$		-	40	48	V
Capacitance	at $V_R = 0 V$; f = 1 MHz	- C _D	-	33	40	pF
	at V _R = 12 V; f = 1 MHz		-	18	-	pF

ELECTRICAL CHARACTERISTICS GSOT36C (T_{amb} = 25 °C unless otherwise specified) between pin 1 to pin 2 or pin 2 to pin1; pin 3 not connected

between pin 1 to pin 2 to pin 1 to pin 2 to pin 1, pin o not connected						
PARAMETER	TEST CONDITIONS/REMARKS	SYMBOL	MIN.	TYP.	MAX.	UNIT
Protection paths	Number of lines which can be protected	Nchannel	-	-	1	lines
Reverse stand-off voltage	Max. reverse working voltage	V _{RWM}	-	-	36.5	V
Reverse voltage	at I _R = 1 μA	V _R	36.5	-	-	V
Reverse current	at V _R = 36.5 V	I _R	-	-	1	μA
Reverse breakdown voltage	at I _R = 1 mA	V _{BR}	39.5	43.7	47.7	V
Reverse clamping voltage	at I _{PP} = 1 A	V _C	-	50	60	V
	at $I_{PP} = I_{PPM} = 3.5 \text{ A}$		-	60	72	V
Capacitance	at $V_R = 0 V$; f = 1 MHz	- C _D	-	26	33	pF
	at V _R = 18 V; f = 1 MHz		-	10	-	pF

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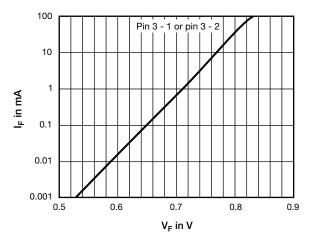


Fig. 1 - Typical Forward Current I_F vs. Forward Voltage V_F

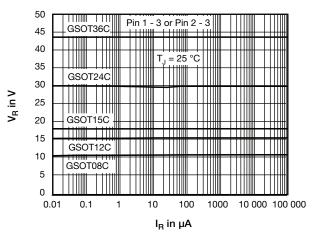


Fig. 2 - Typical Reverse Voltage V_R vs. Reverse Current I_R

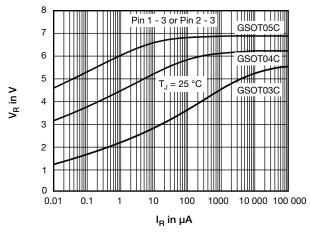


Fig. 3 - Typical Reverse Voltage V_R vs. Reverse Current I_R

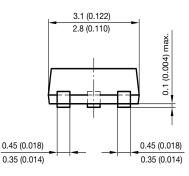
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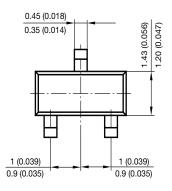
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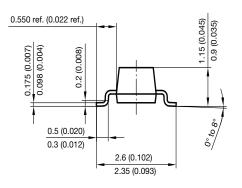


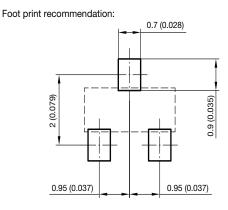
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PACKAGE DIMENSIONS in millimeters (inches): SOT-23

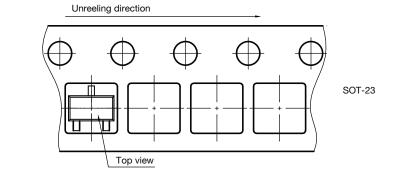








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